



Rev. 1 July 2007

发展工具有害物质布公表格

Hazardous Substance Disclosure Table for:
Development Kits

以下信息安排可用于遵照SJ/T11364-2006标号为电子信息产品造成的污染控制据中国的管理方法要求为污染控制从电子信息产品.

The following information has been made available to comply with SJ/T11364-2006 Marking for Control of Pollution Caused by Electronic Information Products as required by China's Management Methods for the Control of Pollution from Electronic Information Products.

以下Xilinx发展工具有害物质布公表格不是欧盟RoHS应允的。这包括包括的发展工具电路板和附没有单字母的'G'代码的产品或附件。

The following hazardous substance disclosure table applies to Xilinx development kits that are not EU RoHS Compliant. This applies to all development boards and accessory products that are NOT designated by the single letter 'G' at the end of the product/part code.

有毒有害物质名称及含量的标试表格
Table of hazardous substances' name and concentration

Table with 7 columns: Component name, Lead (Pb), Mercury (Hg), Cadmium (Cd), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), and Polybrominated Diphenyl Ethers (PBDE). Rows include Printed Circuit Board Assembly, Cables and Cable Accessories, and Power Supply.

O: 表明在所有同类的材料包含的这种毒性或有害物质为这部分, 根据EIP-A, EIP-B, EIP-C在极限要求之下在JS/T11363-2006
O: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is below the limit requirement in SJ/T11363-2006
X: 表明这种毒性或有害物质可以在所有同类的材料包含为这部分, 根据EIP-A, EIP-B, EIP-C在极限要求之上在SJ/T11363-2006 (信息在这张表格提供了单独地是为遵照SJ/T11364-2006和管理措施为污染控制由电子信息产品。)
X: Indicates that this toxic or hazardous substance may be contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is above the limit requirement in SJ/T11363-2006 (Information provided in this table is solely for compliance with SJ/T11364-2006 and the Management Measures for the Control of Pollution by Electronic Information Products.)

不伤环境产品使用期间:
The Environment Friendly Using Period for these products is:



以下信息安排可用于遵照SJ/T11364-2006标号为电子信息产品造成的污染控制据中国的管理方法要求为污染控制从电子信息产品。

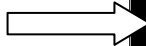
The following information has been made available to comply with SJ/T11364-2006 Marking for Control of Pollution Caused by Electronic Information Products as required by China's Management Methods for the Control of Pollution from Electronic Information Products.

以下危害物质透露表适用于Xilinx覆装晶片積體電路是欧洲RoHS豁免的产品。

这只包括'FFG'or 'BFG'三个文字代码只表示. 文字代码在于Xilinx产品代码前面。

The following hazardous substance disclosure table applies to Xilinx ball grid array flip chip packages that are EU RoHS Compliant by exemption. This only includes products designated by the three letter package code of 'FFG' or 'BFG'. The package code is located on the front of Xilinx products as the example below shows.

标准积体电路
 代码的例子
 Example of a Xilinx
 standard integrated
 circuit package
 code



有毒有害物质名称及含量的标试格式

Table of hazardous substances' name and concentration

| 部件名称 Component name | 有毒有害物质或元素 | | | | | |
|---------------------------|-----------|-----------|-----------|---------------|---------------|-----------------|
| | 铅 (Pb) | 汞 (Hg) | 镉 (Cd) | 六价铬 (Cr6+) | 多溴联苯 (PBB) | 多溴二苯醚 (PBDE) |
| BGA 覆装晶片 BGA Flip Chip | X | O | O | O | O | O |

O: 表明在所有同类的材料包含的这种毒性或有害物质为这部分, 根据EIP-A, EIP-B, EIP-C在极限要求之下在JS/T11363-2006

O: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is below the limit requirement in JS/T11363-2006

X: 表明在所有同类的材料包含的这种毒性或有害物质为这部分, 根据EIP-A, EIP-B, EIP-C在极限要求之上在JS/T11363-2006

X: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is above the limit requirement in JS/T11363-2006

以下信息安排可用于遵照SJ/T11364-2006标号为电子信息产品造成的污染控制据中国的管理方法要求为污染控制从电子信息产品.

The following information has been made available to comply with SJ/T11364-2006 Marking for Control of Pollution Caused by Electronic Information Products as required by China's Management Methods for the Control of Pollution from Electronic Information Products.

Standard integrated circuits include those with package codes:

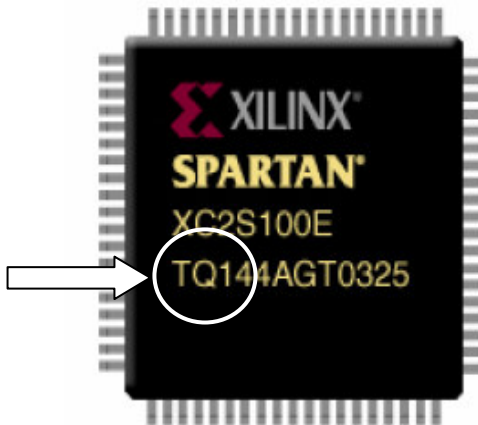
以下危害物质透露表适用于所有Xilinx标准积体电路. Xilinx 标准积体电路由二个文字代码只表示.

如果集成电路有第三文字代码, 代表它不是一个标准积体电路, 这张透露表不适用.

The following hazardous substance disclosure table applies to **ALL** Xilinx standard integrated circuits. Xilinx standard integrated circuits are denoted by only two letters in the package code. If the integrated circuit has a third letter in the package code, it is NOT a standard integrated circuit and this disclosure table does not apply.

Standard integrated circuits include those with package codes BG, BF, CP, CS, FG, FF, FS, FT, HQ, HT, PC, PD, PQ, SF, SO, TQ, VO, VQ

标准积体电路
代码的例子
Example of a Xilinx
standard integrated
circuit package
code



有毒有害物质名称及含量的标试格式

Table of hazardous substances' name and concentration

| 部件名称 Component name | 有毒有害物质或元素 | | | | | |
|---------------------------------------|-----------|-----------|-----------|---------------|---------------|-----------------|
| | 铅 (Pb) | 汞 (Hg) | 镉 (Cd) | 六价铬 (Cr6+) | 多溴联苯 (PBB) | 多溴二苯醚 (PBDE) |
| 标准积体电路 Standard Integrated Circuit | X | O | O | O | O | O |

O: 表明在所有同类的材料包含的这种毒性或有害物质为这部分, 根据EIP-A, EIP-B, EIP-C在极限要求之下在 JS/T11363-2006
O: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is below the limit requirement in JS/T11363-2006
X: 表明在所有同类的材料包含的这种毒性或有害物质为这部分, 根据EIP-A, EIP-B, EIP-C在极限要求之上在 JS/T11363-2006
X: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is above the limit requirement in JS/T11363-2006

以下信息安排可用于遵照SJ/T11364-2006标号为电子信息产品造成的污染控制据中国的管理方法要求为污染控制从电子信息产品。

The following information has been made available to comply with SJ/T11364-2006 Marking for Control of Pollution Caused by Electronic Information Products as required by China's Management Methods for the Control of Pollution from Electronic Information Products.

以下XilinxUSBX有毒有害物质布公表格是欧盟RoHS豁免的。

The following hazardous substance disclosure table applies to Xilinx USBX cable which is EU RoHS compliant by exemption.

有毒有害物质名称及含量的标试格式

Table of hazardous substances' name and concentration

| 部件名称 Component name | 有毒有害物质或元素 | | | | | |
|--|-----------|-----------|-----------|---------------|---------------|-----------------|
| | 铅 (Pb) | 汞 (Hg) | 镉 (Cd) | 六价铬 (Cr6+) | 多溴联苯 (PBB) | 多溴二苯醚 (PBDE) |
| 电线和电缆附件 Cables and Cable Accessories | X | 0 | 0 | 0 | 0 | 0 |

O: 表明在所有同类的材料包含的这种毒性或危害物质在EIP-A, EIP-B, EIP-C极限要求之下
JS/T11363-2006

O: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is below the limit requirement in SJ/T11363-2006

X: 表明在所有同类的材料包含的这种毒性或危害物质为这部分, 根据EIP-A, EIP-B, EIP-C 在JS/T11363-2006 极限要求之上(在这张格式提供的信息完全是为遵照SJ/T11364-2006污染控制由电子信息产品和管理措施)

X: Indicates that this toxic or hazardous substance may be contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is above the limit requirement in SJ/T11363-2006 (*Information provided in this table is solely for compliance with SJ/T11364-2006 and the Management Measures for the Control of Pollution by Electronic Information Products.*)

不伤环境产品使用期间：

The Environment Friendly Using Period for this products is:

